

WP2: Low Q^2 Tracker - Status

Electron-Ion Collider UK Gathering 2025



Ken Livingston, Dec 2025

Simon Gardner (Glasgow)

Derek Glazier (Glasgow)

Ken Livingston (Glasgow)

Rachel Montgomery (Glasgow)

Gary Penman (Glasgow)

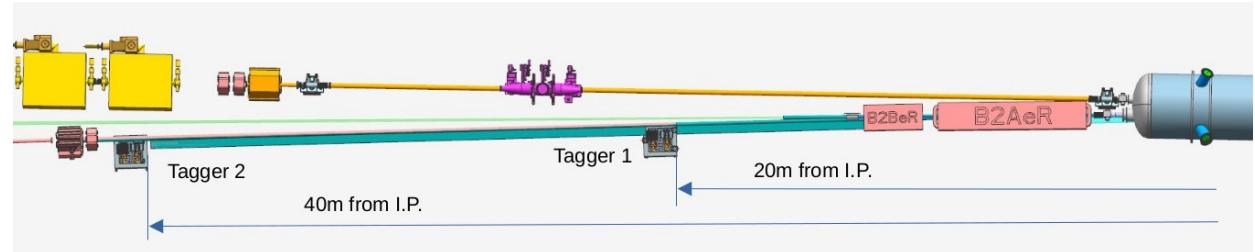
Daria Sokhan (Glasgow)

Dima Maneuski (Glasgow, PPE)

Rob Apsimon (Lancaster, Accel)

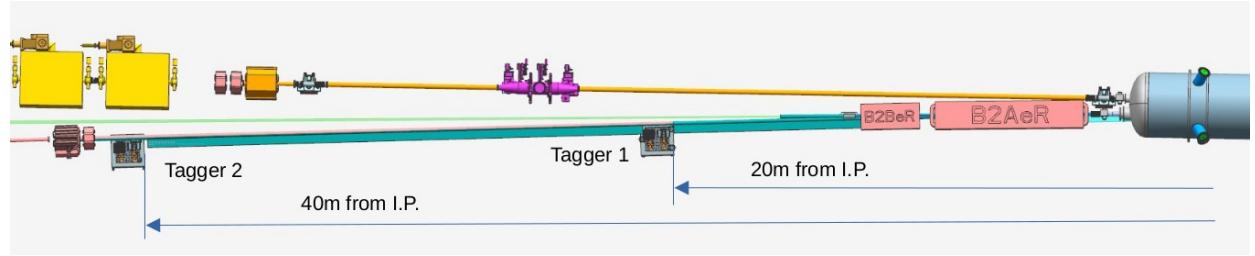
Jaroslav Adam (Prague, Calorimeter)

Yulia Furletova (Jlab/EIC, Far Backward)



Outline

- Low Q^2 Tagger Overview
- Tracker Requirements
- Technology
- Design
- Performance
- Current status
- Next steps
- Summary

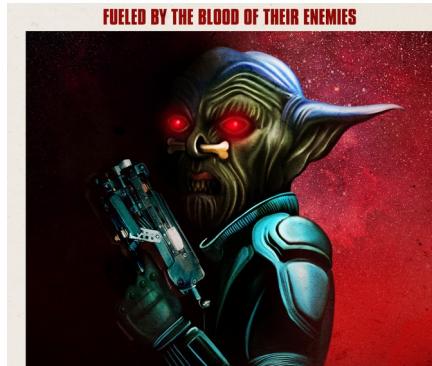


Short Xmas Quiz

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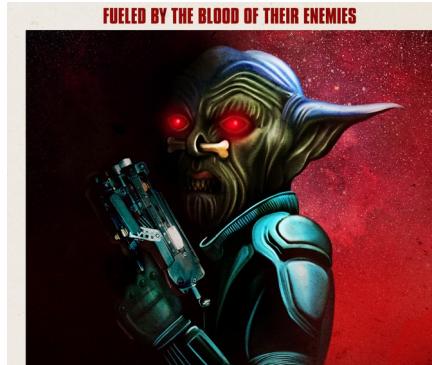
Q1. Who are they ?

_____ / _____



Short Xmas Quiz

Q1. Who are they ? _____ / _____



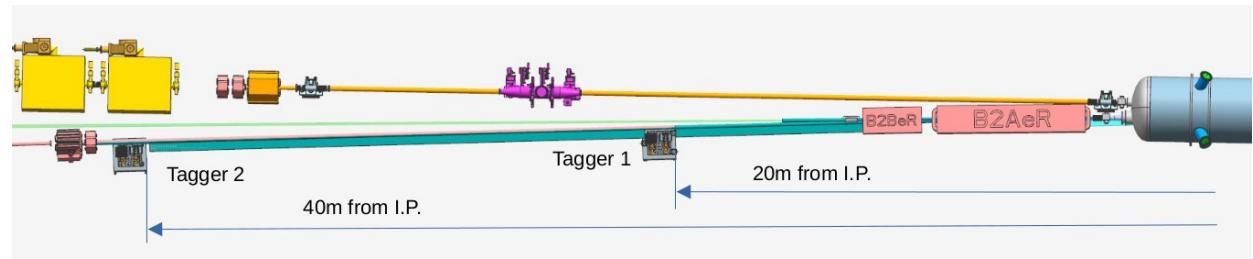
Q2. Who might be their enemies ? _____ / _____

Low Q^2 Tagger Overview

Low Q^2 electrons (~0 deg)

(Quasi Real photons)

Missed by main detector

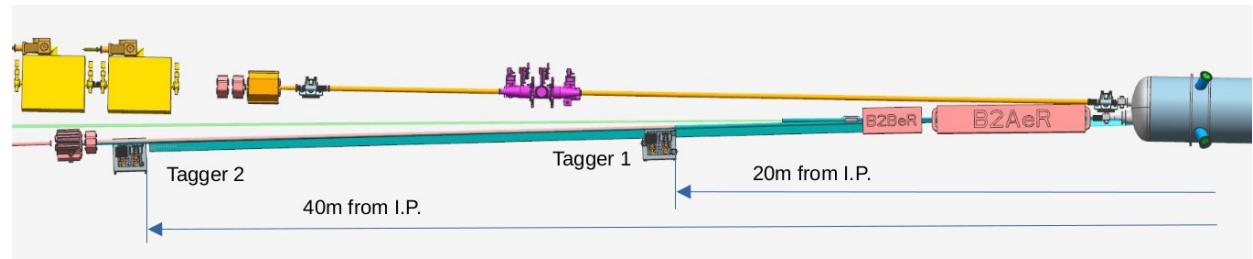


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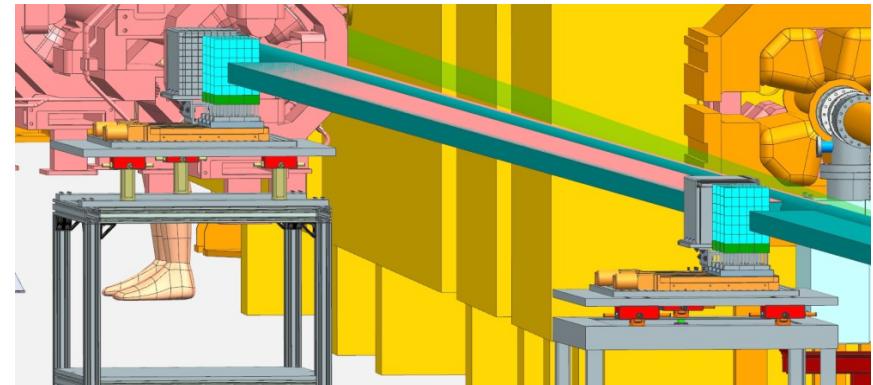
Detectors very close to electron beam

Swamped by bremsstrahlung electrons

Detector + DAQ for high BG rates

Can't be inside the beam vacuum (yet)

Complicated beam pipe + window

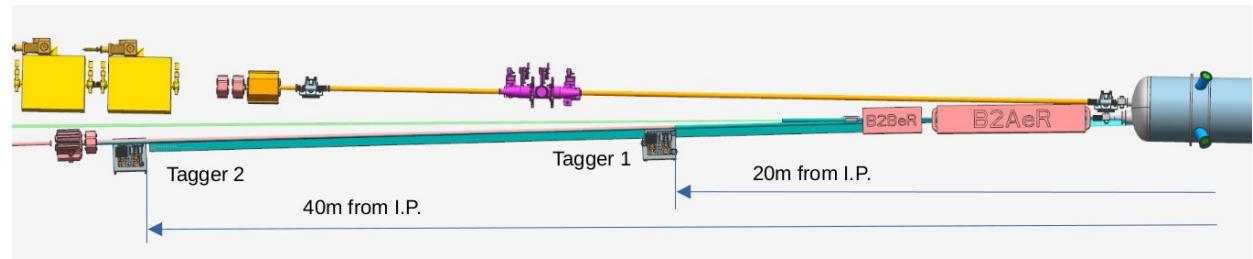


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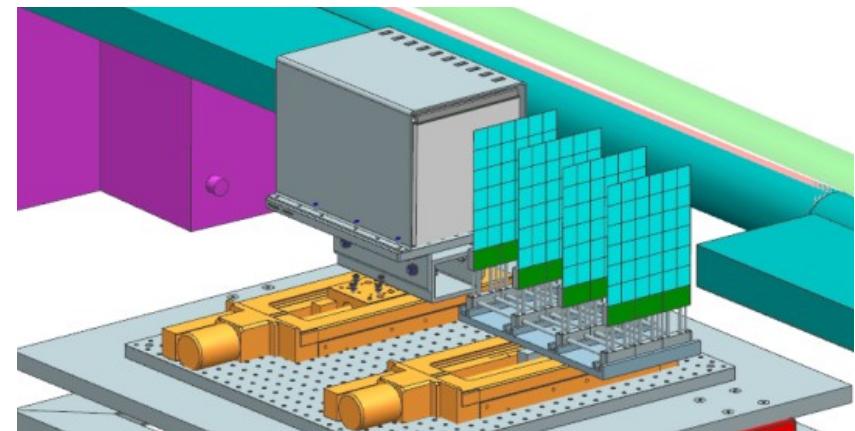
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Tracker + Calorimeter

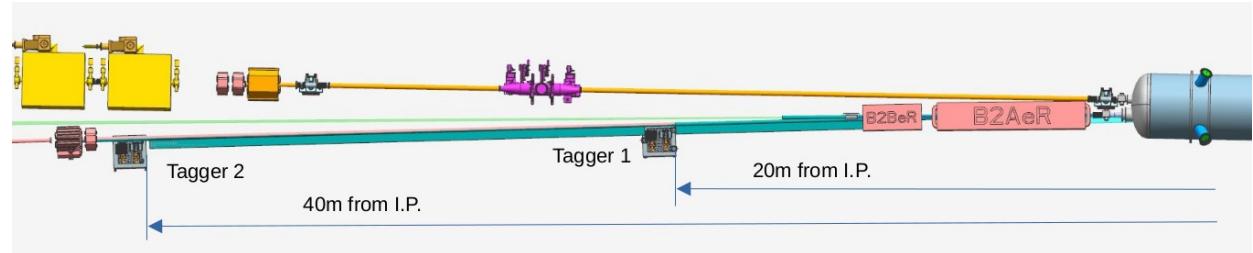


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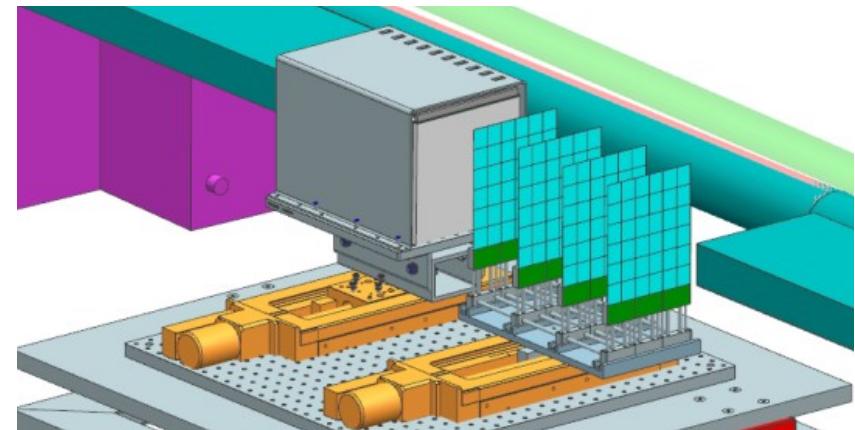
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WP2

Tracker + Calorimeter



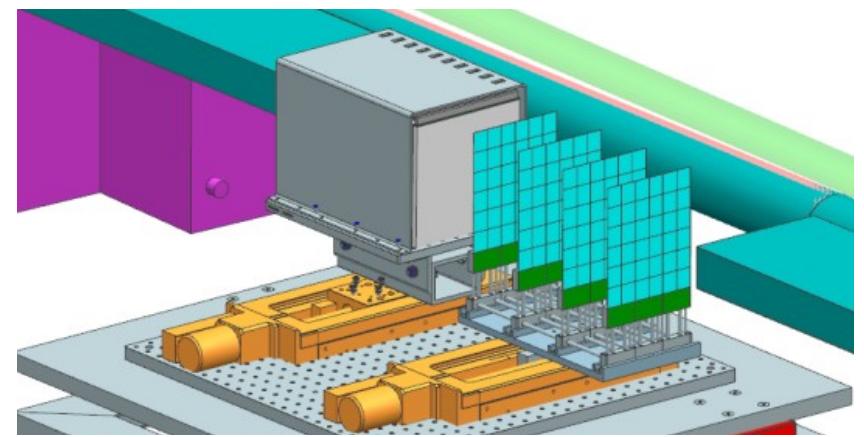
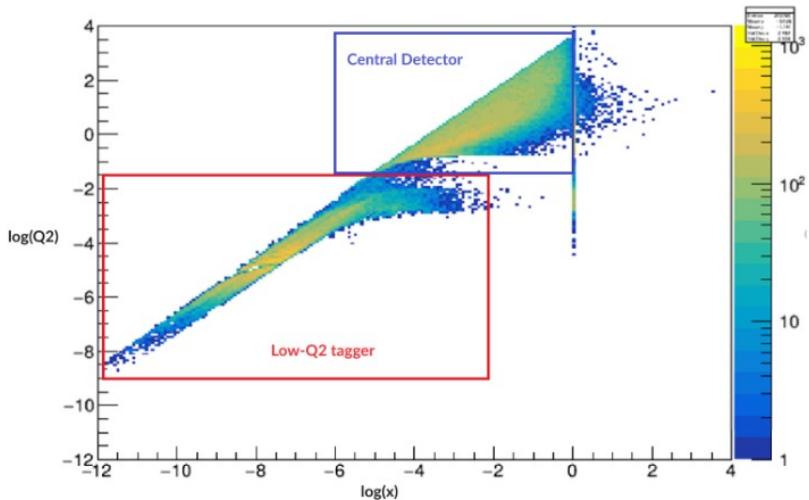
Tracker Requirements

Position res (is everything!): Q^2 , E, P, angle, bg separation: $< 100\mu\text{m}$

Timing res: separate beam buckets: $<< 10\text{ns}$

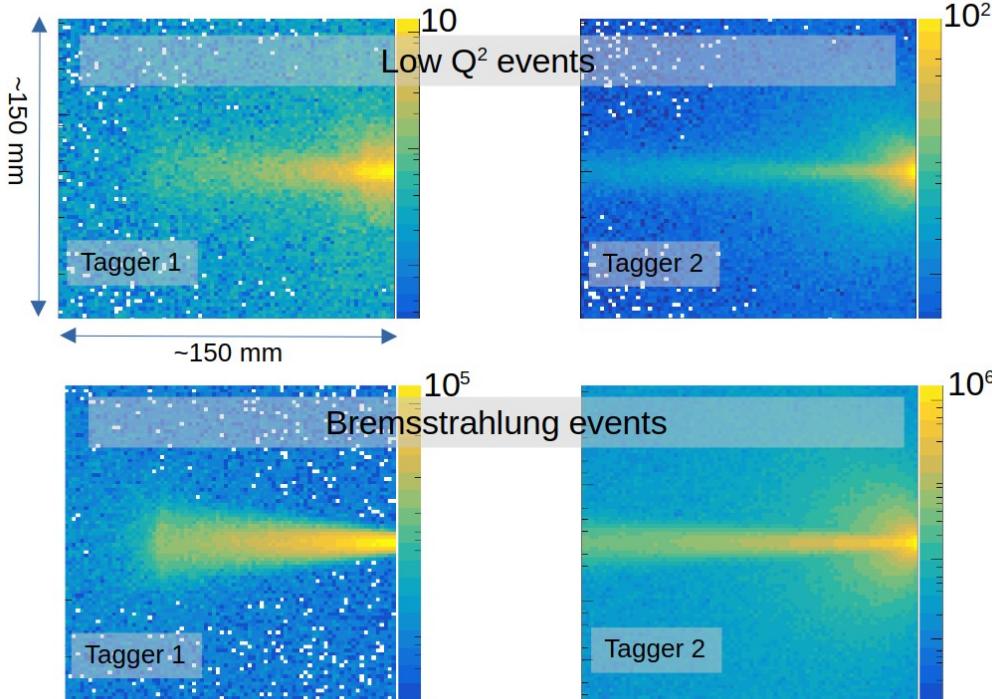
Rate capability: Just slightly less than infinity Hz. (Next slide)

Acceptance: Everything that isn't captured by the main detector, or the magnet. Changing with every beamline design iteration

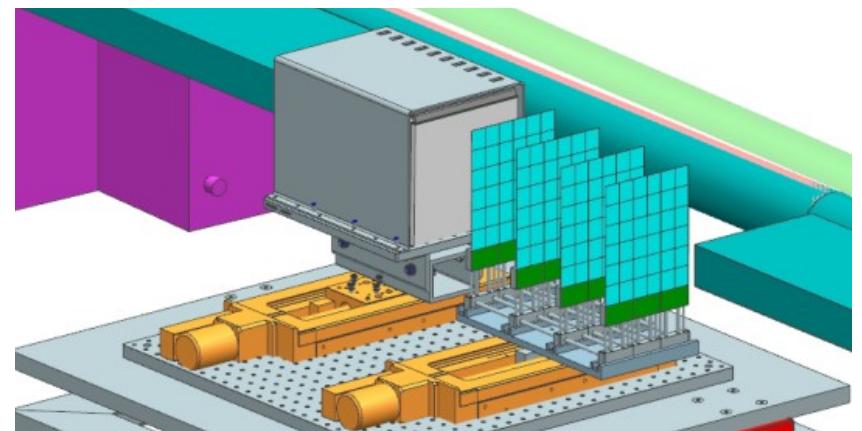


Tracker Requirements Rates

Low Q^2 tagger rates (kHz / mm²): 18/275 @ 10^{34} cm⁻² mm⁻¹

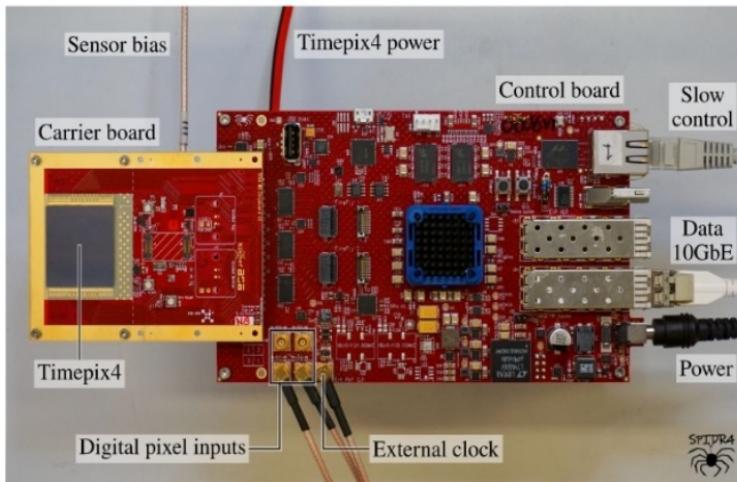


Raw hits from two taggers	> 10 GHz
Data rate from raw hits:	> 600 Gb/s
Pipeline filter on "hadron" at	~ 500 kHz
Reduced rate to tape:	< 20 Gb/s



Technology

Characteristic	Value
Technology	65 nm - 10 metal
Pixel size	55 x 55 μm
Sensor size	512 x 448 pixels, 4-side buttable
Sensitive area	6.94 cm^2 (2.47 x 3.0 cm)
Packet size	64 bits
Readout method	data driven
Maximum rate / unit area	3.58×10^6 hits / mm^2 / s
Maximum rate / pixel	10.8 kHz / pixel
ToT Energy resolution	< 1 keV
Time resolution	195 ps
Readout bandwidth	163.84 Gb/s (16 x 10.24 Gb/s)

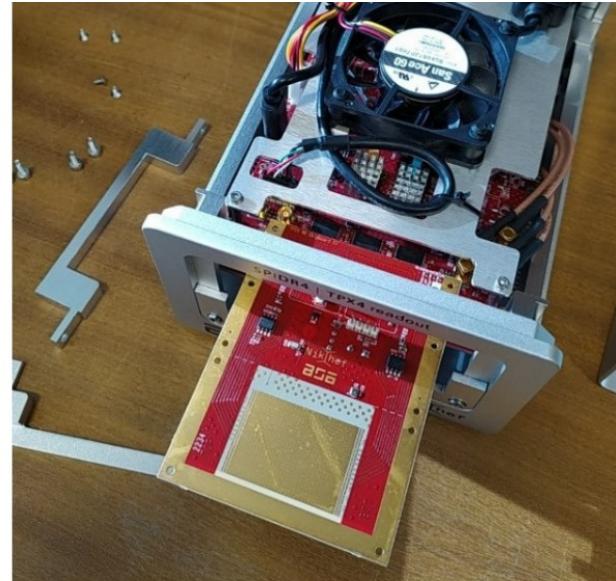


Timepix4 + Si Hybrid CERN Medipix

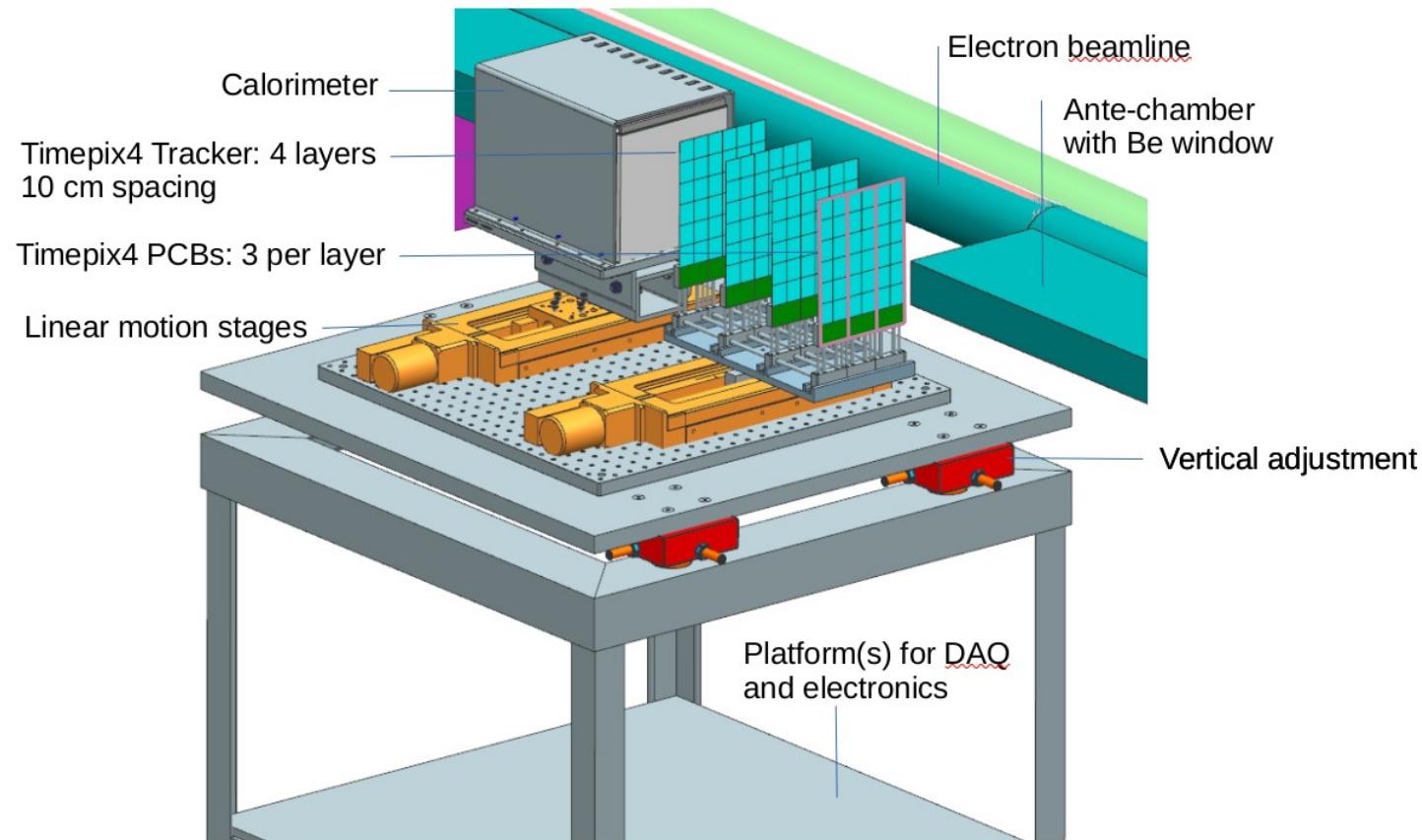
X. Llopart et al 2022 JINST 17 C01044

SPIDR4 Readout, NIKHEF

K. Heijhoff et al 2024, pp. 1-1, doi: [10.1109/NSS/MIC/RTSD57108.2024.10657478](https://doi.org/10.1109/NSS/MIC/RTSD57108.2024.10657478).

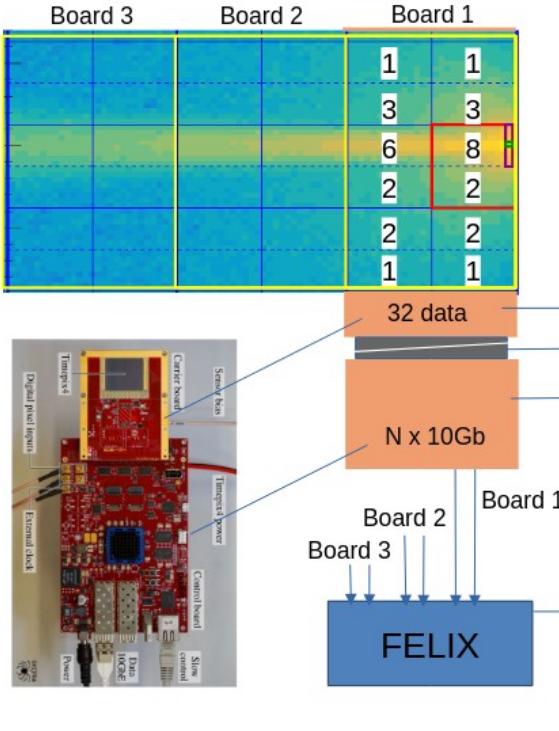


Design



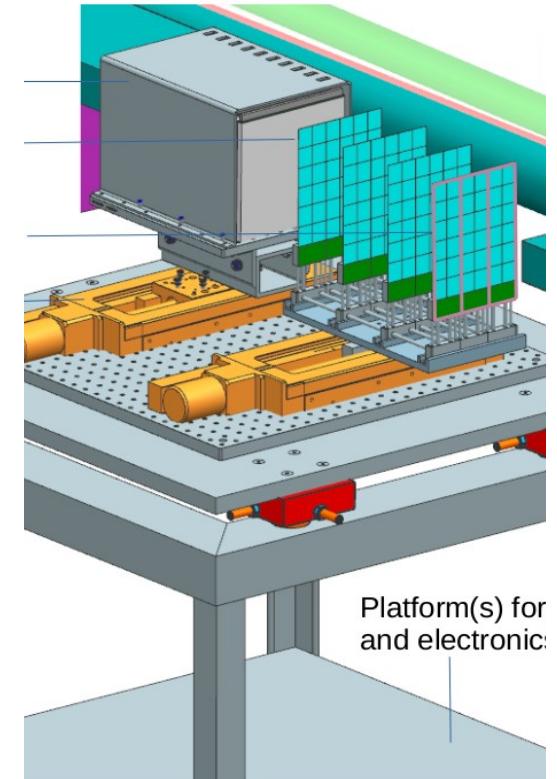
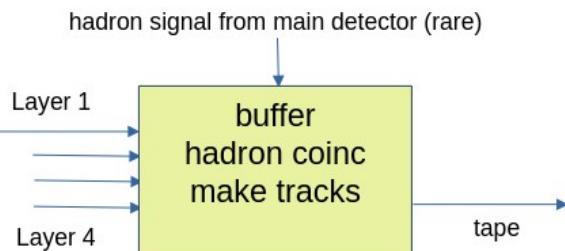
Design

Single layer schematic



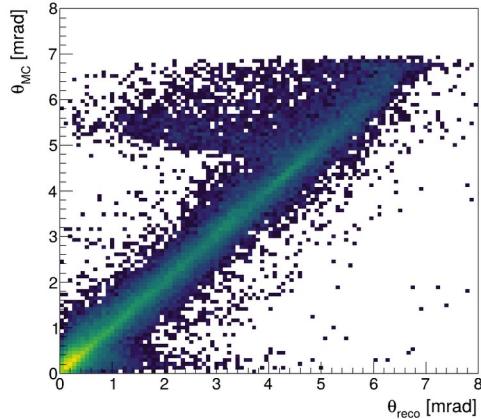
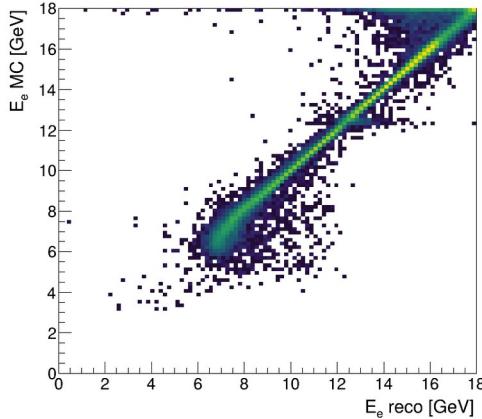
2 trackers
4 layers per tracker
3 boards per layer
6 (3x2) timepix4 hybrids per board
32 data lines total

PCB (from NIKHEF carrier board)
SAMTEC cable
RD0/SPIDR4++

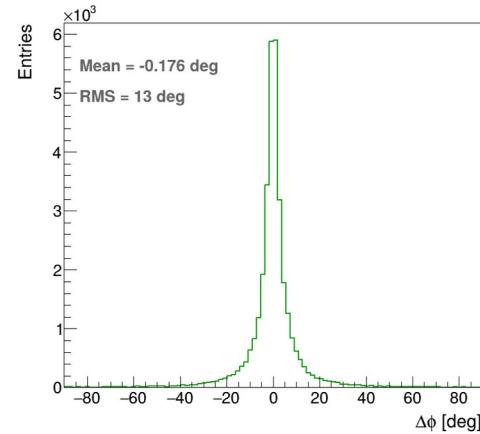
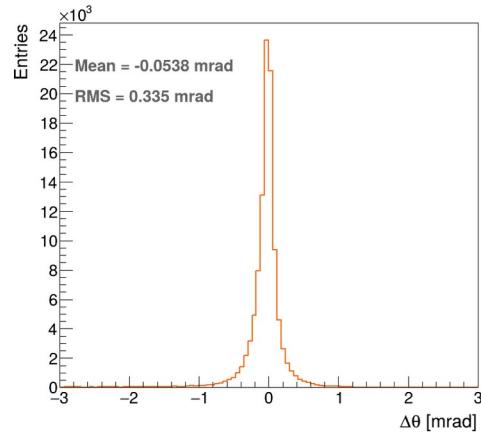
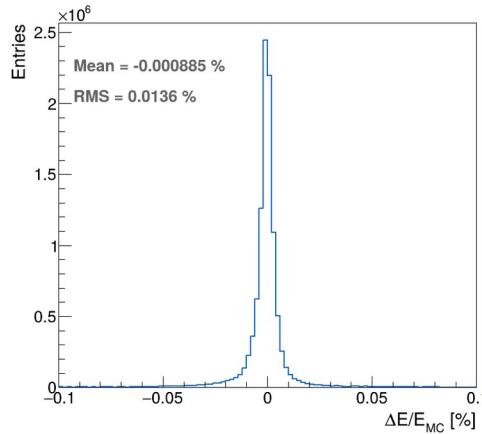
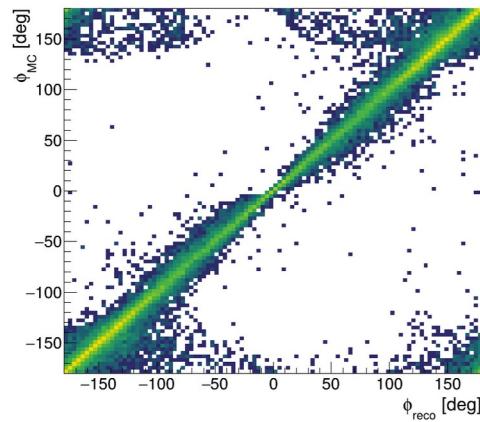


Performance

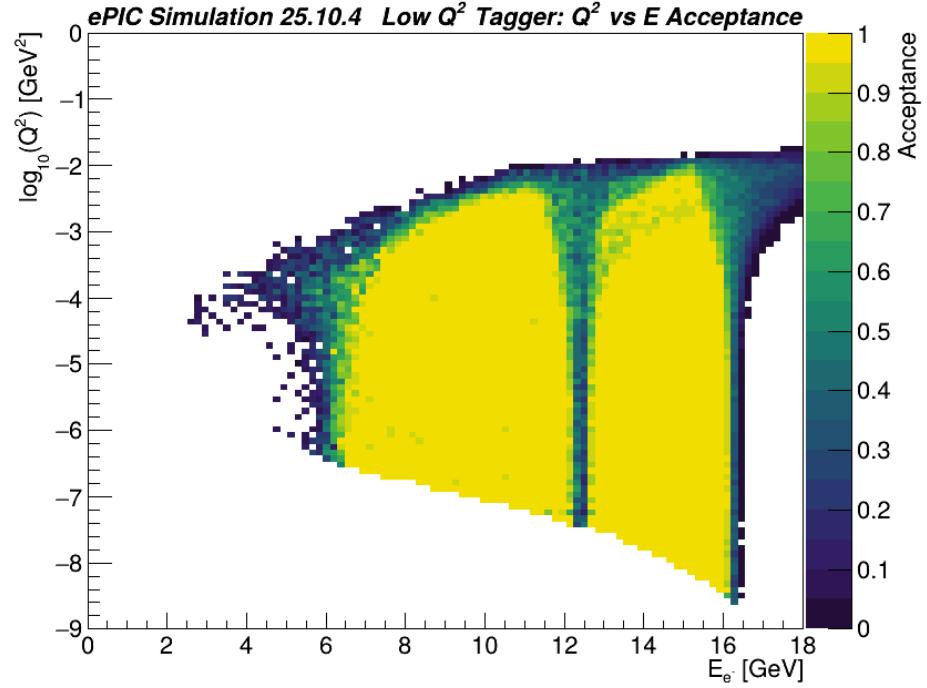
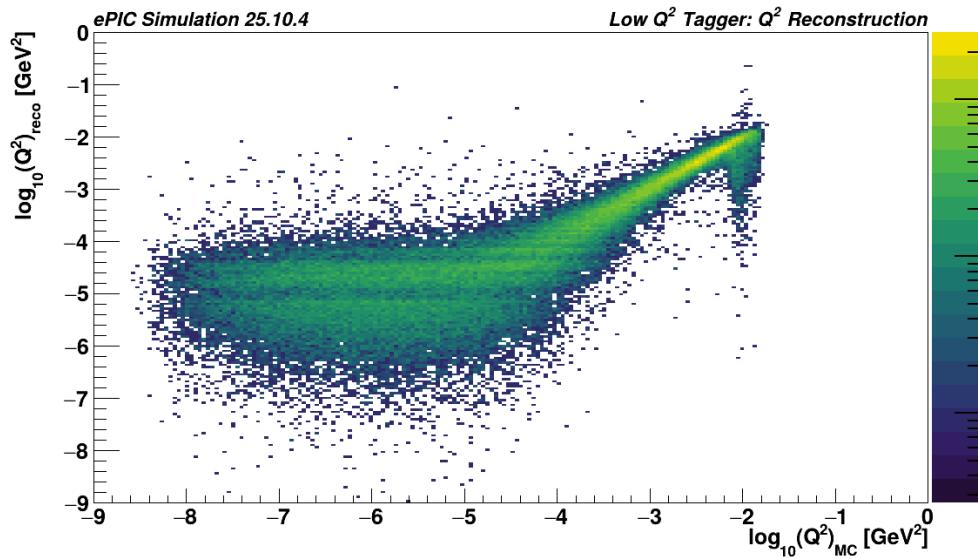
ePIC Simulation 25.10.4



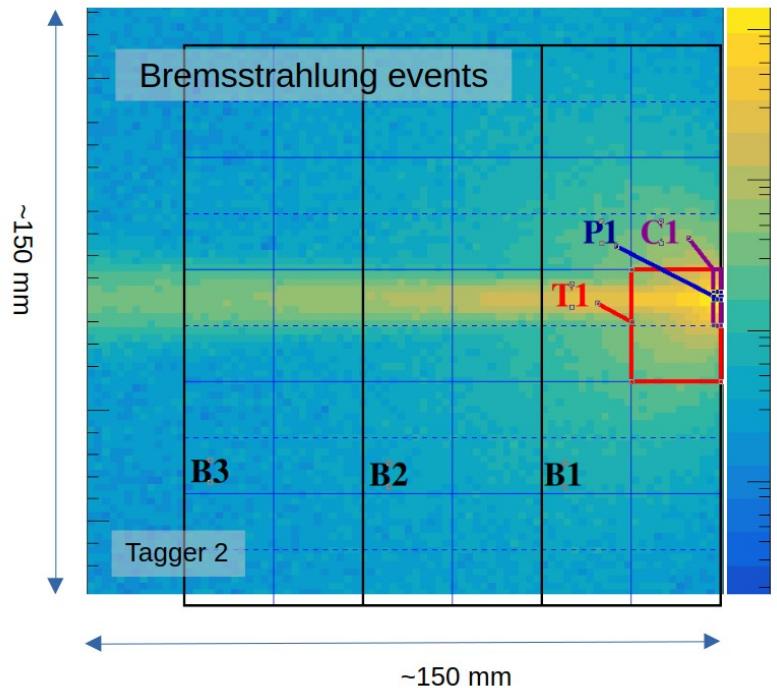
Low- Q^2 Tagger Resolutions



Performance



Performance



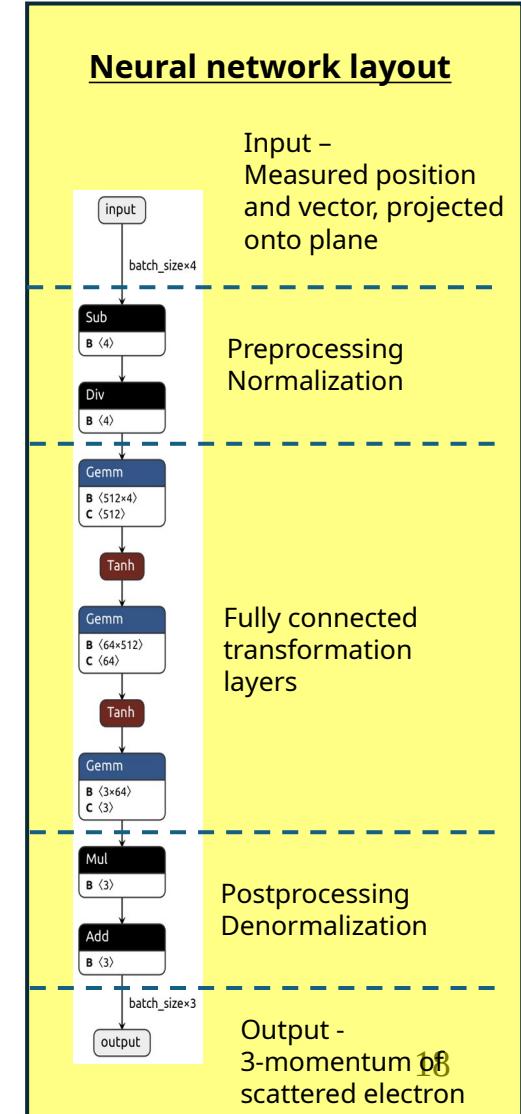
- P1:** Hottest pixel
- C1:** Hottest column
- T1:** Hottest Timepix4 Hybrid
- Bn:** Boards with tiled Timepix4s

Component	Event Rate	Unit	Data Rate (Gb/s)
Maximum Hits			
Pixel (P1)	70 (100)	kHz	
Double column (C1)	5 (5.5)	MHz	
Timepix4 (T1)	0.6 (2.5)	GHz	38 (163)
Board (B1)	1.5 (5.0)	GHz	96 (326)
Integrated Hits			
Tracker 1	2	GHz	130
Tracker 2	7	GHz	480
Tracker Total	9	GHz	600
Integrated hits in coincidence with hadron (500 Hz)			
Signal	300	MHz	4
Signal + BG + random sample	1500	MHz	< 20

Current status

Simulation, reconstruction, benchmarking

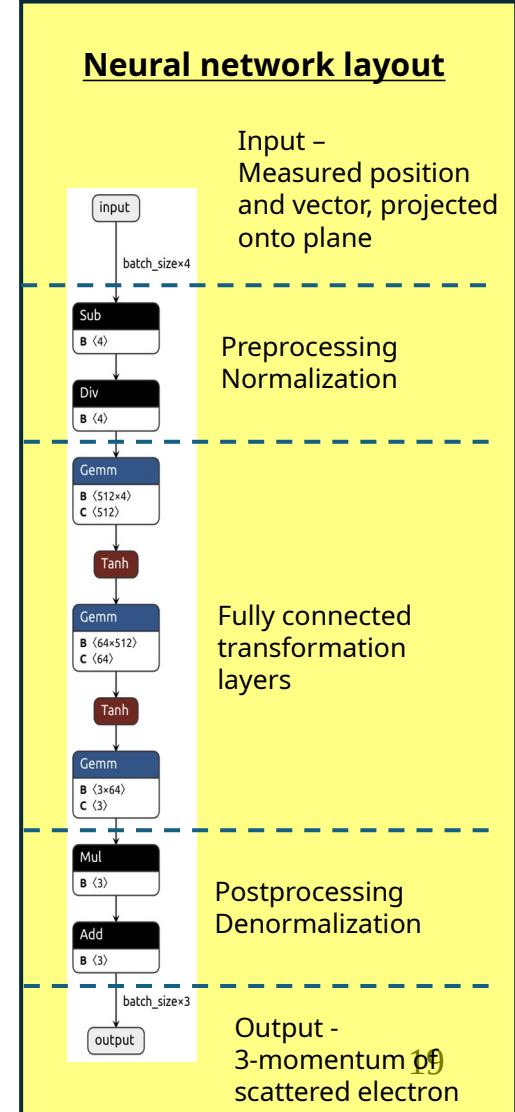
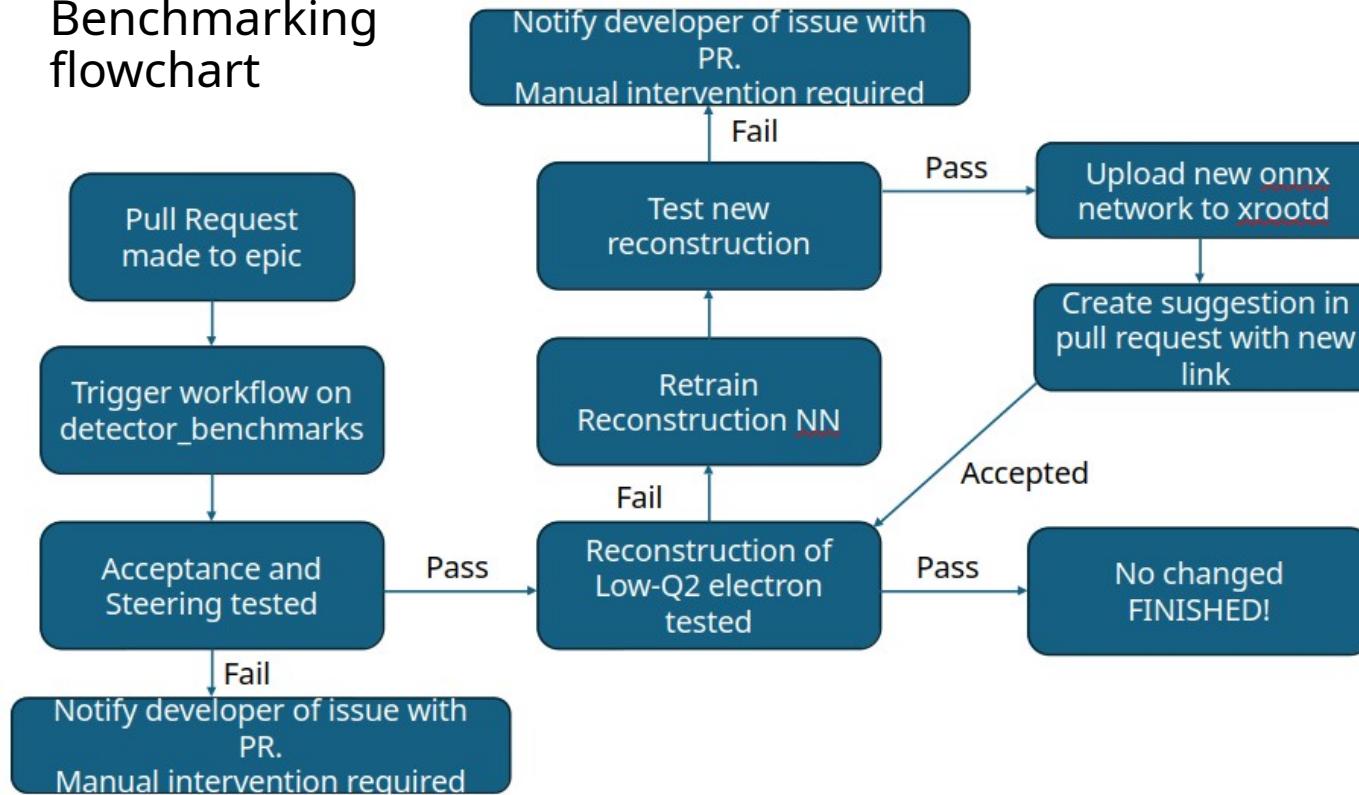
- NN transforms measured vector at tagger into electron momentum at IP.
 - Currently implemented as default method in EICrecon.
- The network is sensitive to, and needs retraining when these change:
 - Beamlime optics (Will break reconstruction)
 - Tagger or exit window material (May change resolutions and biases)
 - Tagger layer or station locations (May change resolutions and biases)
 - MC sample (Uneven distribution over the phasespace results in sample bias)
- Benchmark set up to automatically test and retrain NN for any geometry change through the epic/detector_benchmarks CI tests
 - Creates code suggestion on triggering PR to update location of new onnx artifact uploaded by benchmark to xrootd server.



Current status

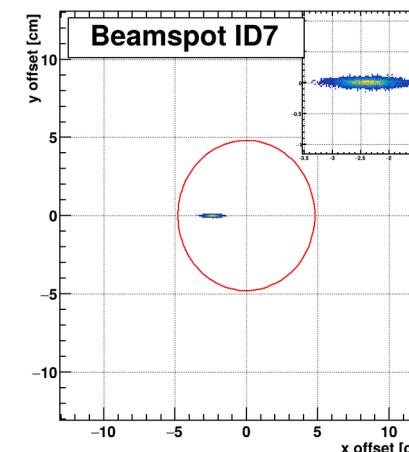
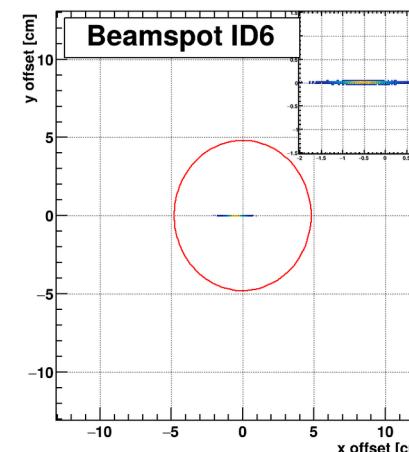
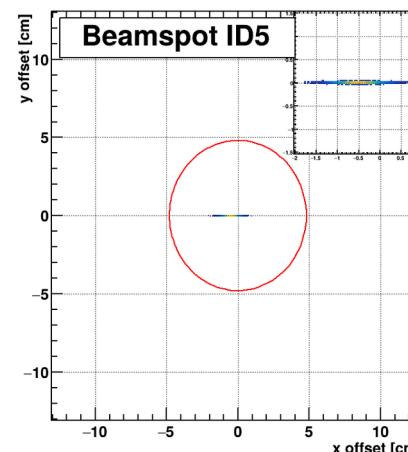
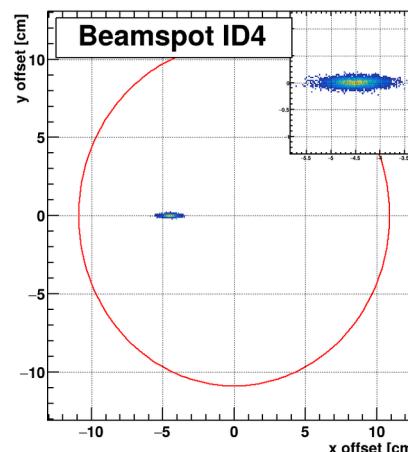
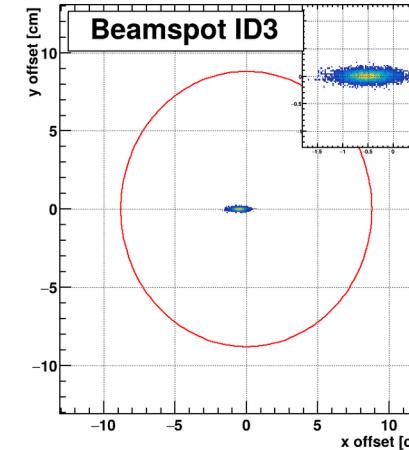
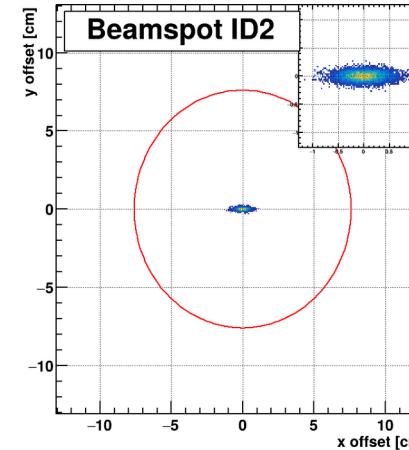
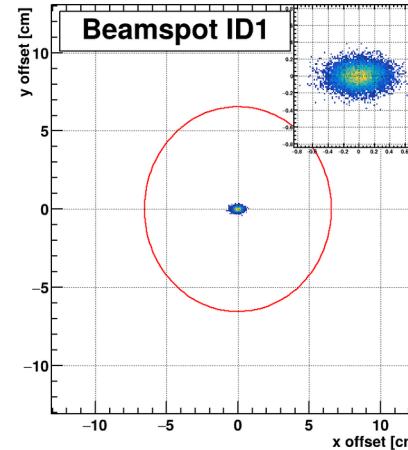
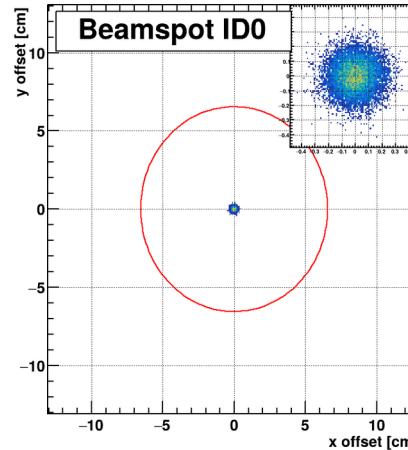
Simulation, reconstruction, benchmarking

Benchmarking flowchart



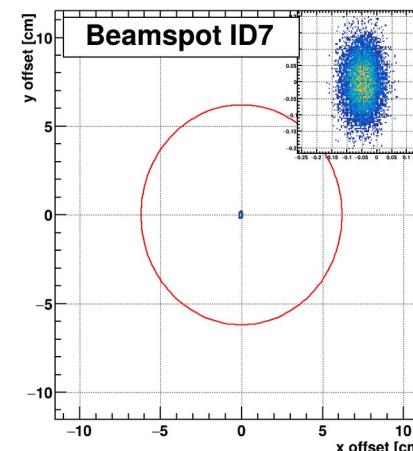
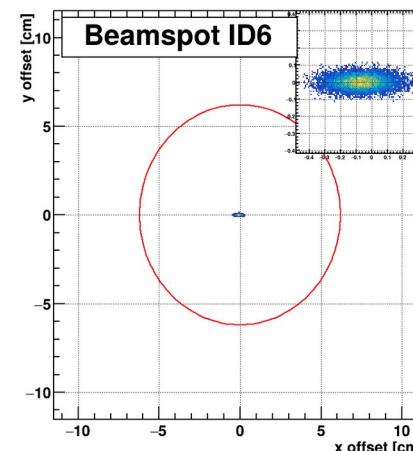
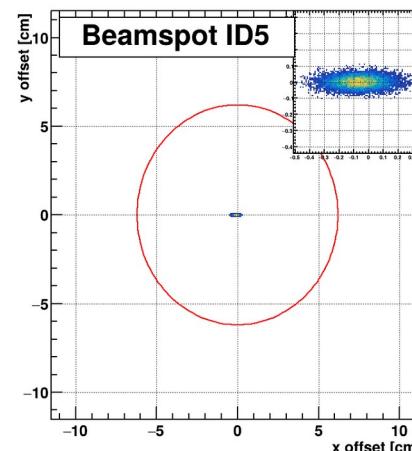
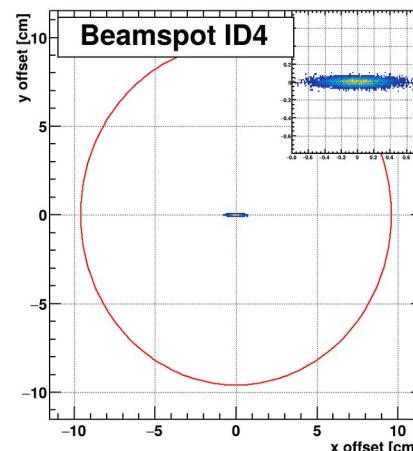
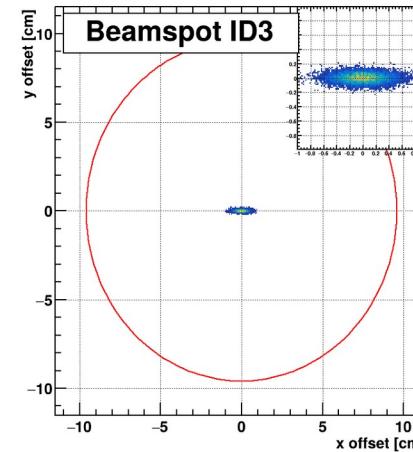
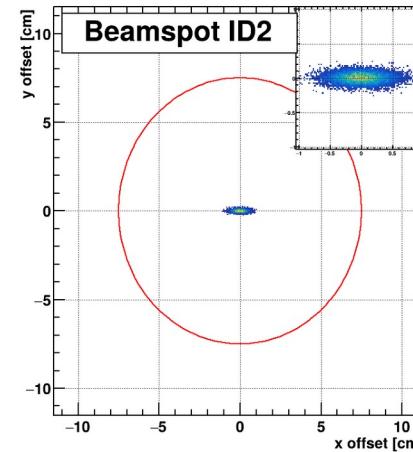
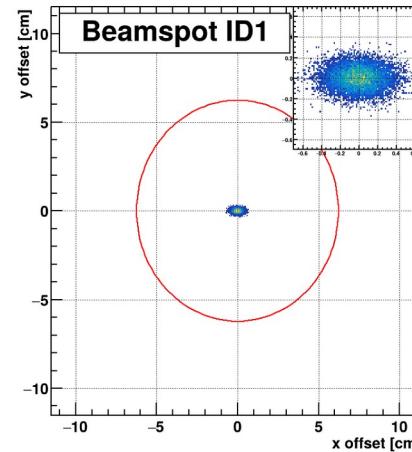
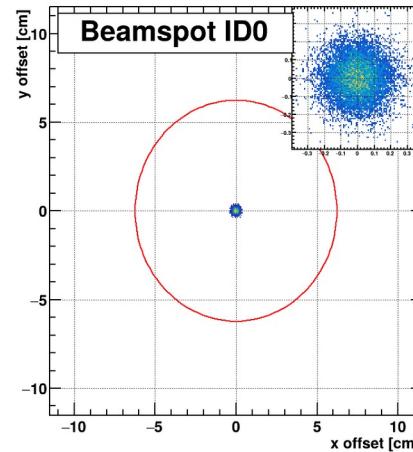
Far Backward Steering and Acceptance

Current Beamlne: Beamspot off center of 03eR (ID5)



Far Backward Steering and Acceptance

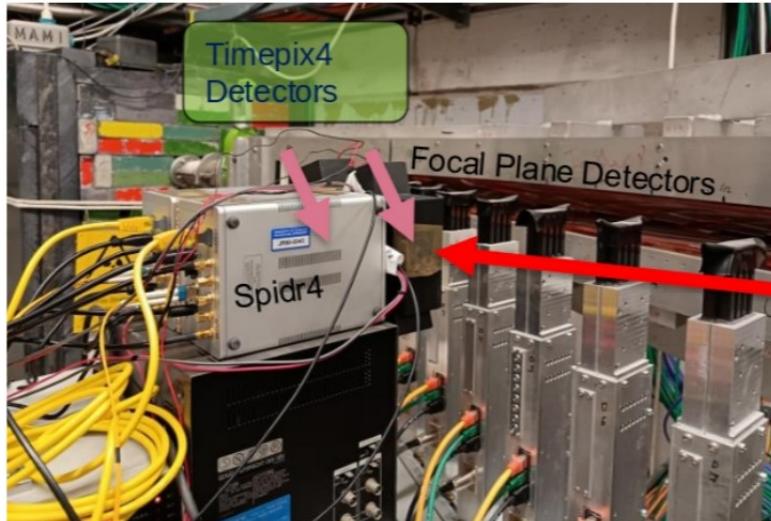
Updated Beamline: Nicely centered beam



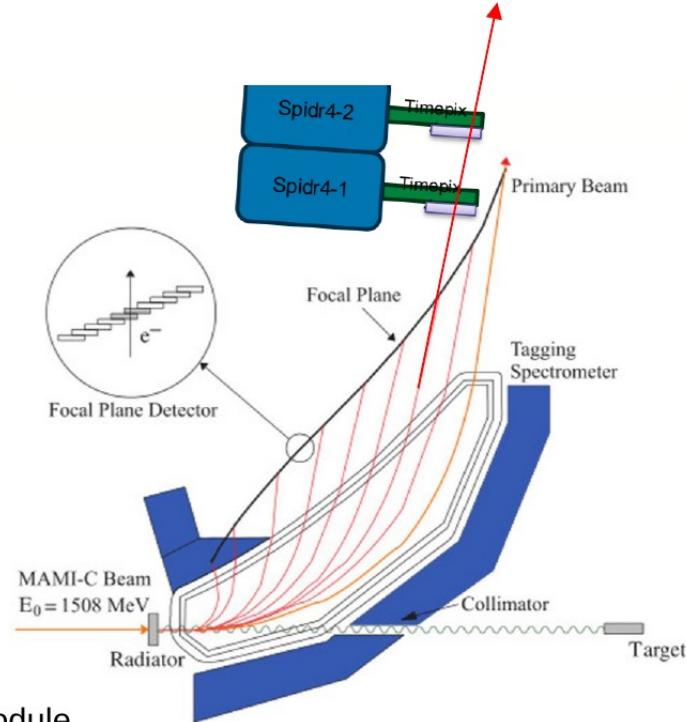
Current status

Mainz beam test

Two layer Timepix4 tracker on focal plane of bremsstrahlung tagger

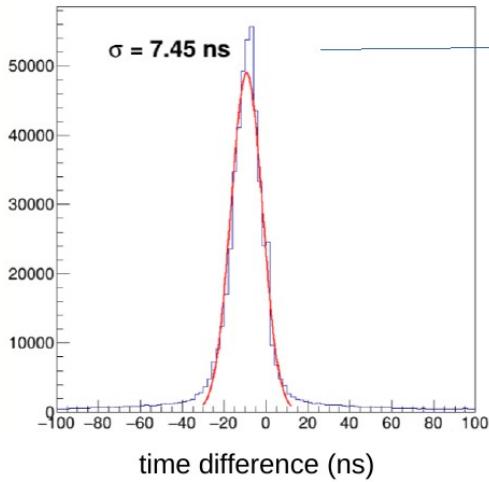


Setup
Control: 1G Wired ethernet
Data: 2 x 10 Gb Fibre readout to server
Sync: External 40MHz clock via NIKHEF control module
Time ref: Tagger focal plane scintillator <1ns.



Current status

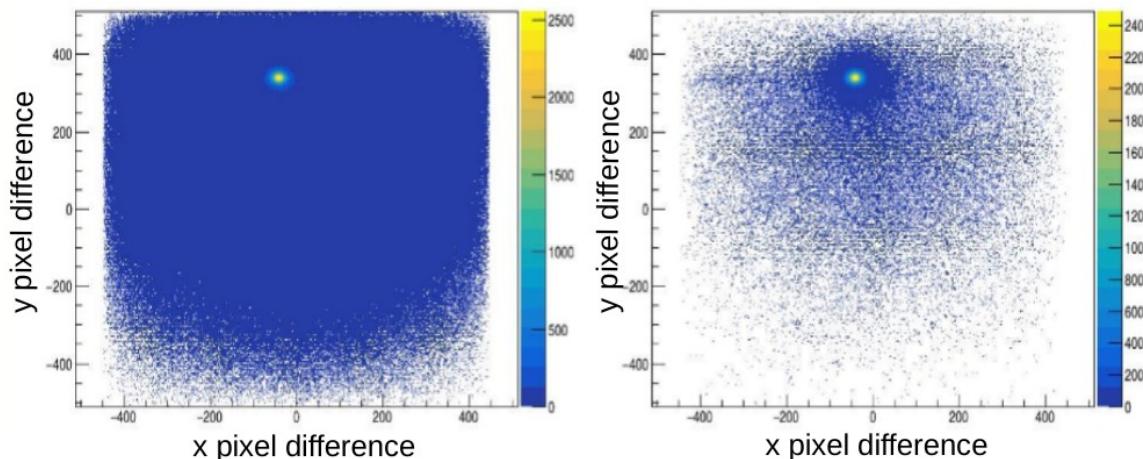
Mainz test – first results with Timepix4



7.34 ns uncorrected (300um Si)

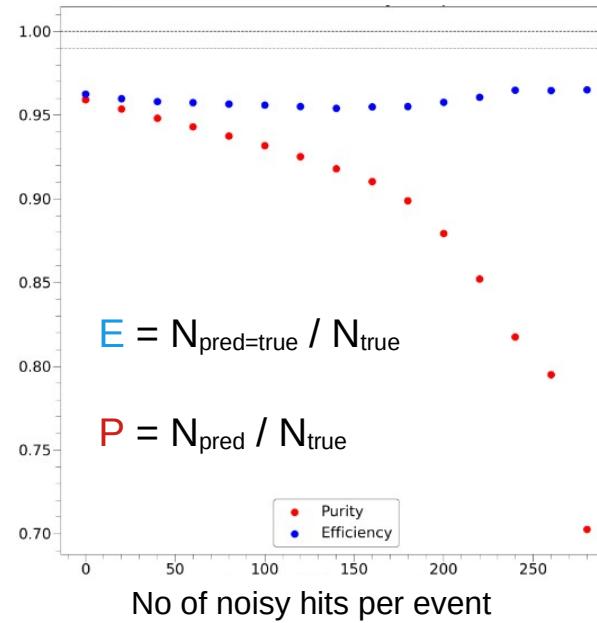
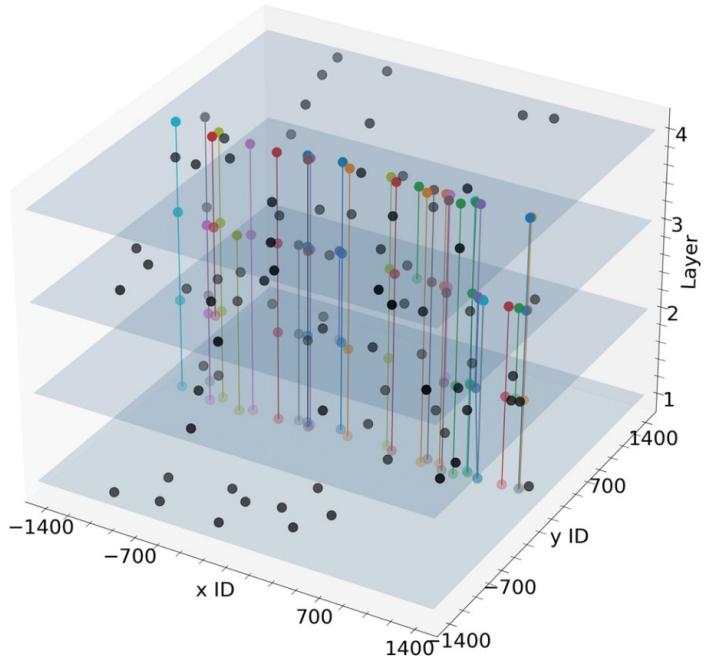
3.5 ns after global walk correction

< 0.5 ns expected with 100um Si
after full corrections



Current status Tracking

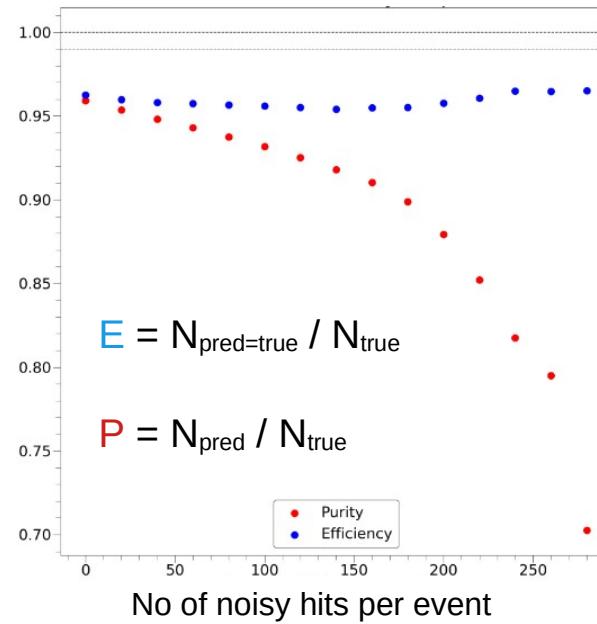
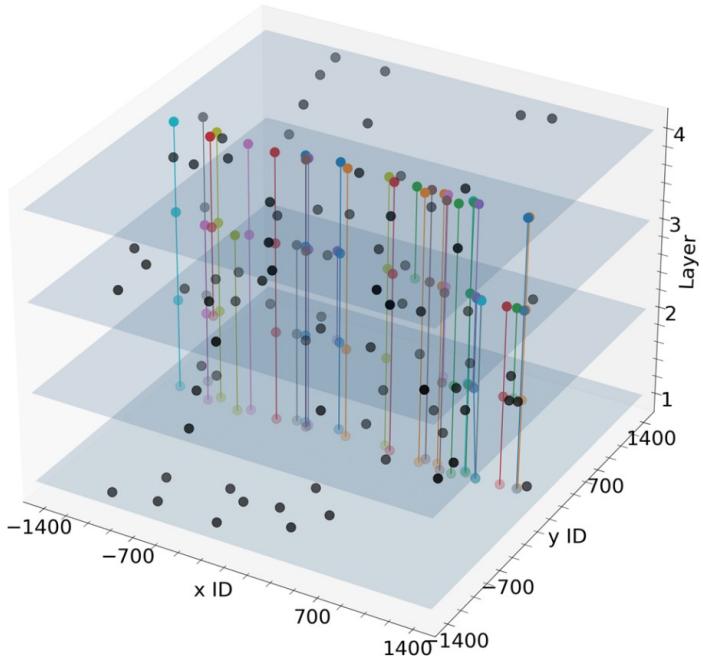
GNN + Object condensation to be implemented on FPGA



Next steps

Tracking

GNN + Object condensation to be implemented on FPGA



R. Tyson (Newly appointed)

Generalized tracking in high noise environment
(Muon Tomography and EIC)

FPGA

Some lovely new results
... but subject to NDA.

Next steps

Cooling

Heat per Timepix4: 4.5W
No per Tracker: <144

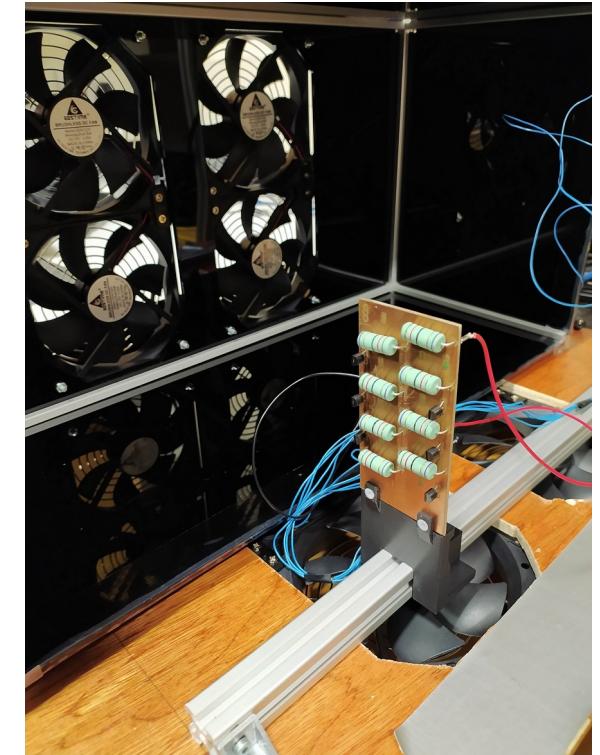
Heat per Tracker: ~500W

Not in Vacuum - Use forced air cooling

Test kit:

Timepix4: big resistor (TPR)
Layer board: PCB with 8 x TPR + temp sensors

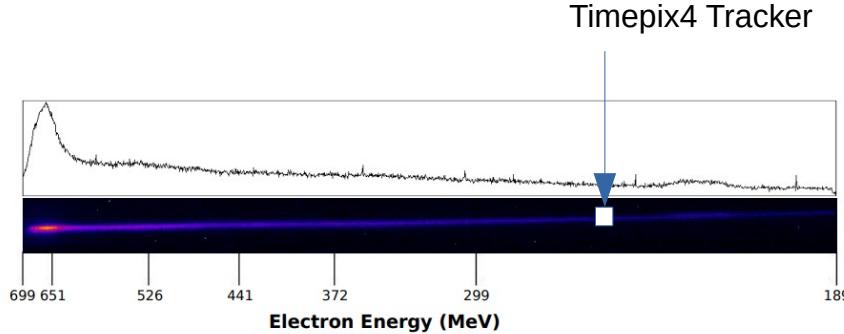
Readout: LED temp displays
Enclosure: Profile + PVC
Cooling: Voltage controlled fans



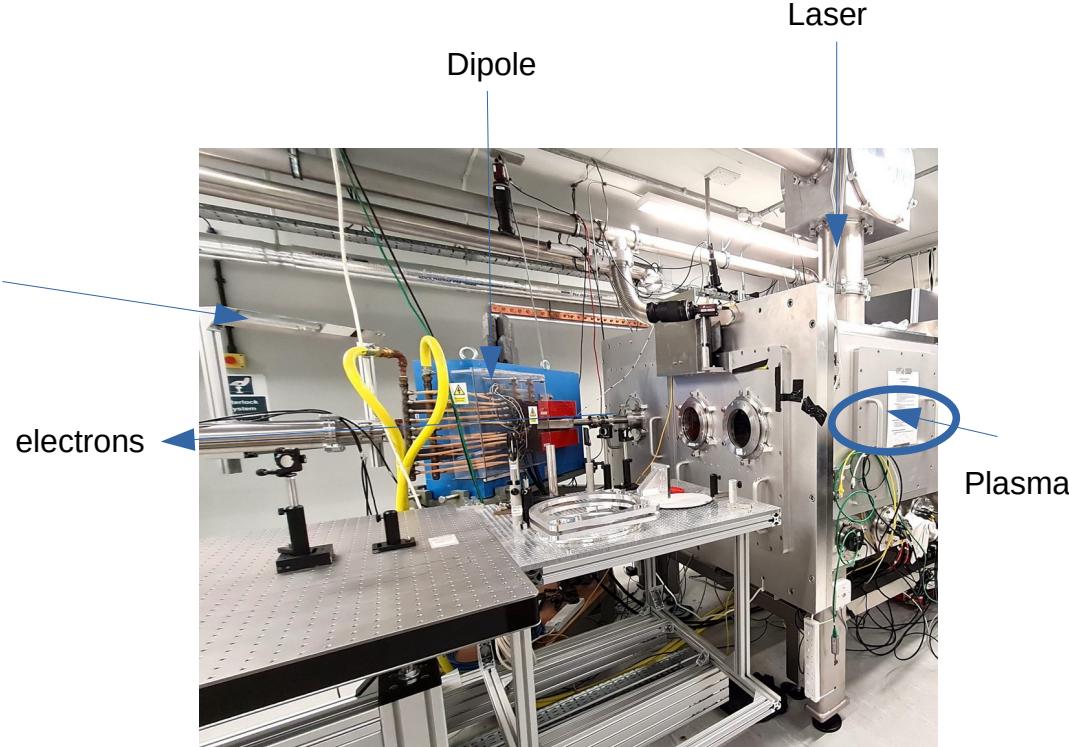
Next steps

Detector tests – could we go to **SCAPA**

Scottish Centre for the Application of Plasma-based Accelerators



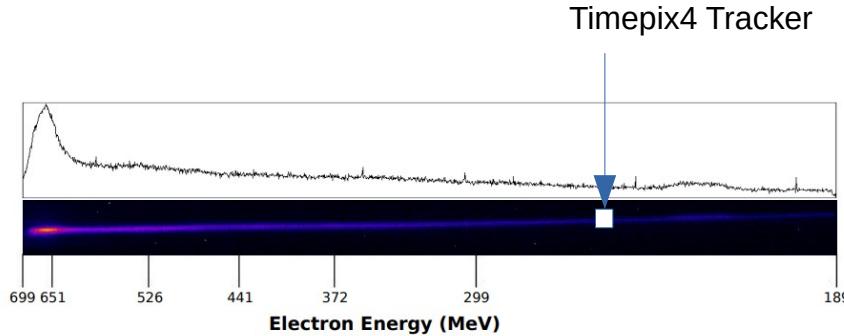
Could we put the tracker after the dipole ?



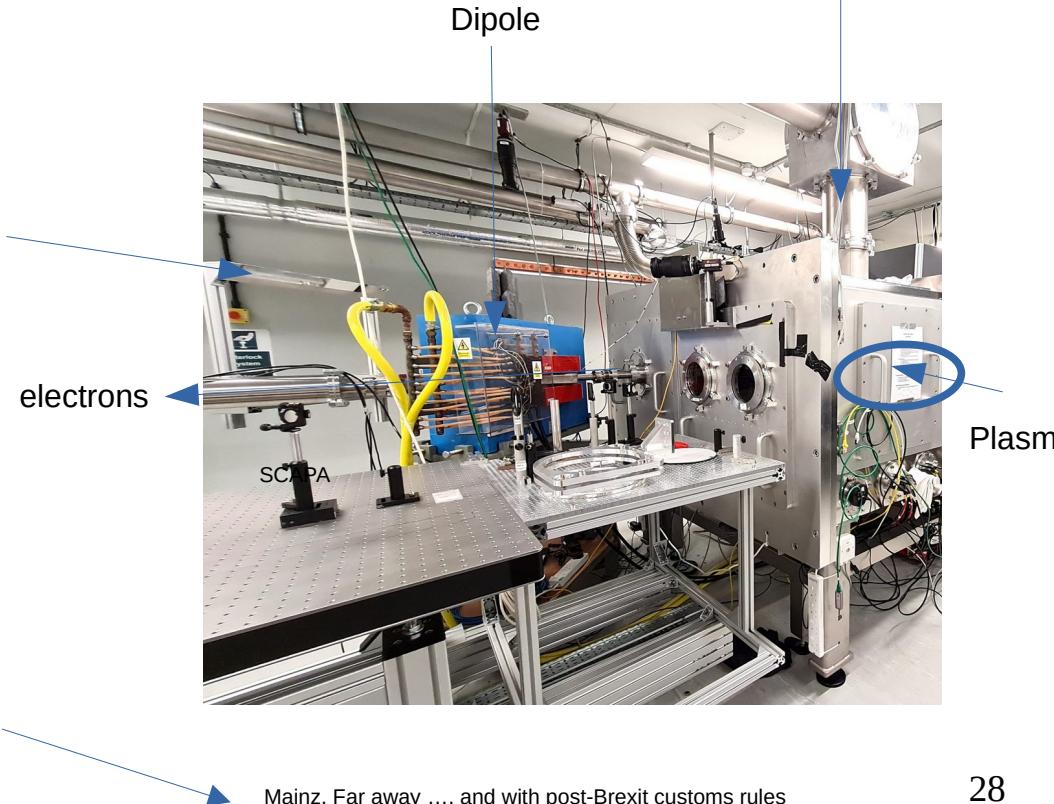
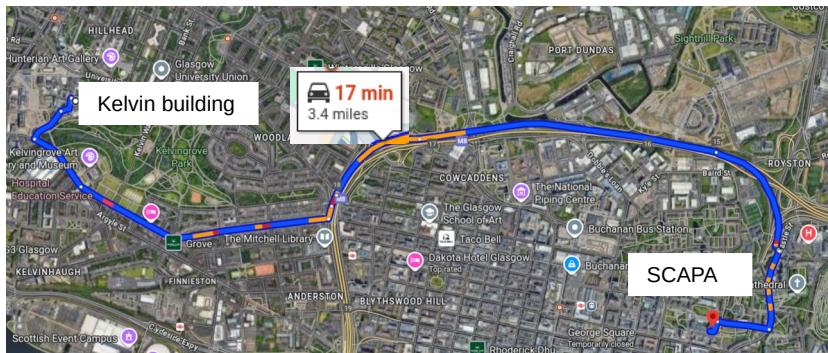
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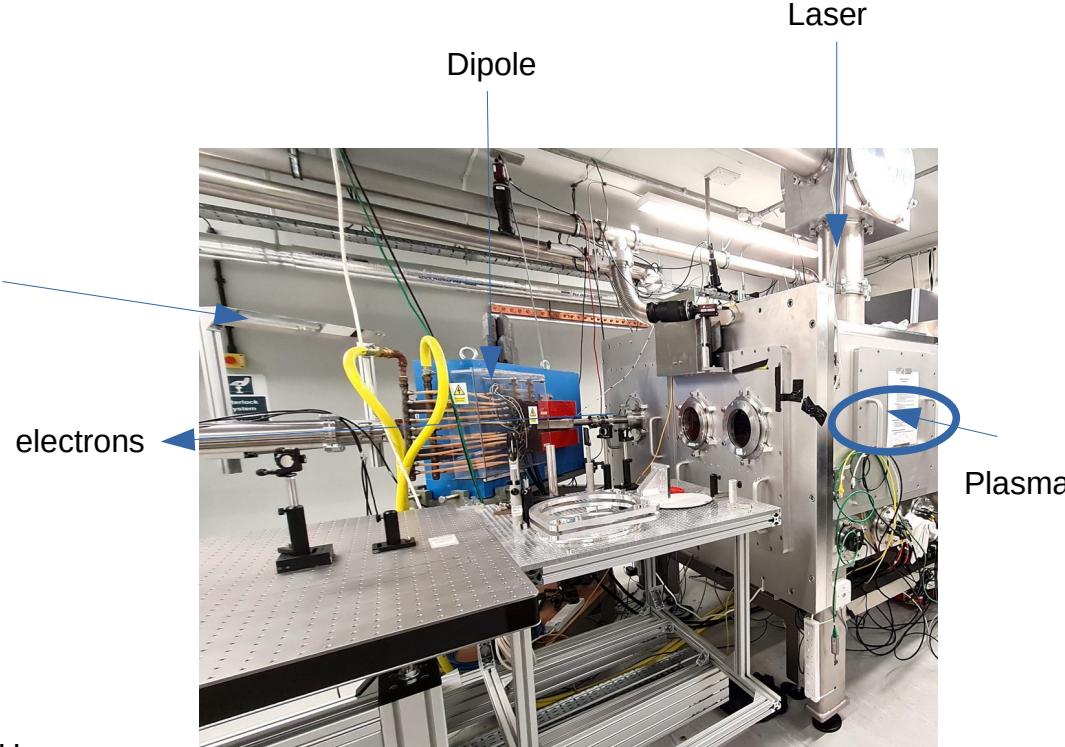
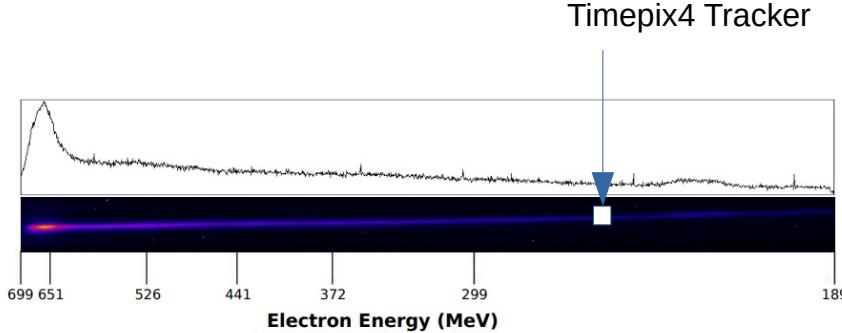
One very big advantage



Next steps

Detector tests – could we go to **SCAPA**

Scottish Centre for the Application of Plasma-based Accelerators



However, it can deliver $\sim 10^9$ electrons in a 10ps burst at 1Hz

Turn it down ? Make a secondary beam ? Visiting SCAPA for discussions in Jan 2026

Next steps

.....

Final design of beamline (ePIC)
Final design of trackers

More tests – SCAPA or overseas
New 4 layer test telescope
Firefly readout fancy FPGA

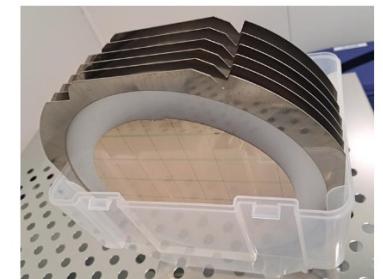
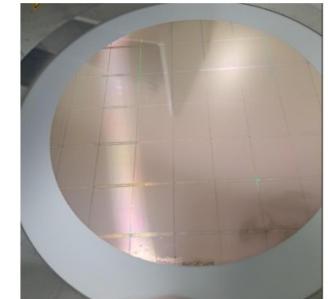
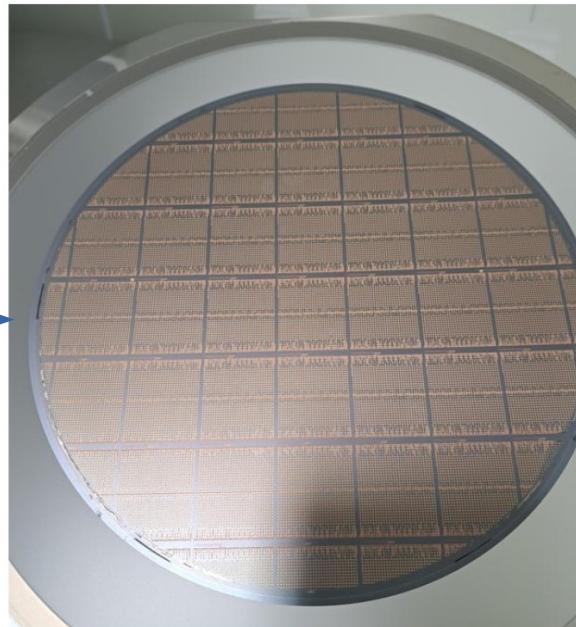
TSVs (Through Silicon Vias)

Layer board to be designed

Clustering, tracking, FGPA, pipelining

DAQ Software chain

Timepix4V0, V1, V2 and V3 Processed wafer delivered by LETI in December



Summary

Design concept for Tracker is complete.

Technology is Timepix4

First beam tests and readout tests completed

Performance (from simulation and design and tests)
Well within requirements.

Next steps:

More tests

TSVs

PCB design and build

Mech design